Fabrication of micrometer-sized conical field emitters using femtosecond laser-assisted etching of silicon

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Background



irradiate with 100-fs 10 kJ/m² pulses































R.H. Fowler and L. Nordheim, Proc. R. Soc. Lond. A (1928)

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gold coating



	anode		
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gold coa	ting		







turn-on field (1 µA/cm²): 1.3 V/µm



threshold field (10 µA/cm²): 2.15 V/µm















Secondary ion mass spectrometry:

- ▶ 10²⁰ cm⁻³ sulfur
- ▶ 10¹⁷ cm⁻³ fluorine



sulfur introduces states in the gap



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Janzén, et al., Phys. Rev. B 29,1907 (1984)

states broaden into a band





sulfur band provides additional electrons





Microstructured silicon

fabricated by simple, maskless process



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▶ is durable

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For a copy of this talk and additional information, see

http://mazur-www.harvard.edu





Y.Y. Lau et al., Phys. Plasmas 1, 2082 (1994)





